PT78ST200 Series

12V 2 Amp Positive Step-Down Integrated Switching Regulator

Power Trends Products from Texas Instruments

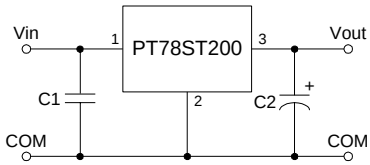
SLTS060A

(Revised 6/30/2000)

- High Efficiency > 87%
- Wide Input Range
- Aluminum Heatsink for Applications with Airflow
- Self-Contained Inductor
- Short Circuit Protection
- Over-Temperature Protection
- Pin Compatible with Linear 3-Terminal, "78" Series Regulators
- Small Footprint

The Power Trends' PT78ST200 is a series of 3-terminal Integrated Switching Regulators (ISRs) that can supply up to 24 watts of regulated 12V power. With a surge capability of 3 Amps and an output voltage that is laser trimmed, it is ideal for inductive load applications such as disk drive motors.

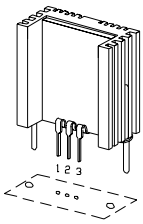
Standard Application



C_1 = Optional 1µF ceramic
C_2 = Required 100µF electrolytic

Pin-Out Information

Pin	Function
1	V_{in}
2	GND
3	V_{out}



SUGGESTED BOARD LAYOUT
COMPONENT SIDE VIEW

Pkg Style 600

Ordering Information

PT78ST2 XX Y

Output Voltage	Package Suffix
12 = 12.0 Volts	**V** = Vertical Mount

Specifications

Characteristics (T_a = 25°C unless noted)	Symbols	Conditions	PT78ST200 SERIES Min	Typ	Max	Units
Output Current	I_o	Over V_{in} range With forced air cooling	0.1*	—	2.0	A
Short Circuit Current	I_{sc}	V_{in} = V_{in} min	—	5.0	—	Apk
Input Voltage Range	V_{in}	0.1 ≤ I_o ≤ 2.0A	16	—	28	V
Output Voltage Tolerance	ΔV_o	Over V_{in} range, I_o= 2.0A T_a= 0°C to +60°C	—	±1.0	±2.0	%Vo
Line Regulation	Reg_{line}	Over V_{in} range	—	±0.4	±0.8	$\%V_o$
Load Regulation	Reg_{load}	0.1 ≤ I_o ≤ 2.0A	—	±0.2	±0.4	$\%V_o$
V_o Ripple/Noise	V_n	V_{in}=17V, I_o=2.0A, V_o=12V	—	120	—	mV_{pp}
Transient Response (with 100µF output cap)	t_{tr}	50% load change V_o over/undershoot	— —	100 5.0	— —	µSec $\%V_o$
Efficiency	η	V_{in}=17V, I_o=2.0A	—	87	—	%
Switching Frequency	f_o	Over V_{in} and I_o ranges	0.95	1.0	1.05	MHz
Absolute Maximum Operating Temperature Range	T_a	—	-40	—	+65	°C
Recommended Operating Temperature Range	T_a	Free Air Convection, (40-60LFM) at V_{in}= 24V, I_o=2A	-40	—	+55**	°C
Thermal Resistance	θ_{ja}	Free Air Convection, (40-60LFM)	—	35	—	°C/W
Storage Temperature	T_s	—	-40	—	+125	°C
Mechanical Shock	—	Per Mil-STD-883D, Method 2002.3	—	500	—	G's
Mechanical Vibration	—	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, Soldered in a PC board	—	10	—	G's
Weight	—	—	—	11	—	Grams

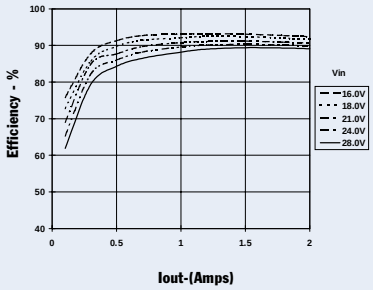
*ISR will operate down to no load with reduced specifications. **See Thermal Derating chart.

Note: *The PT78ST200 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.*

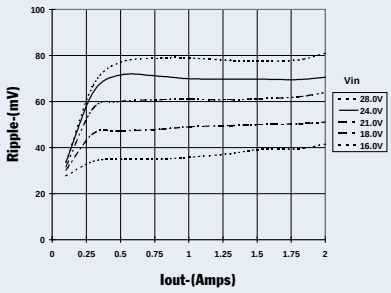
Typical Characteristics

PT78ST212 12.0 VDC (See Note 1)

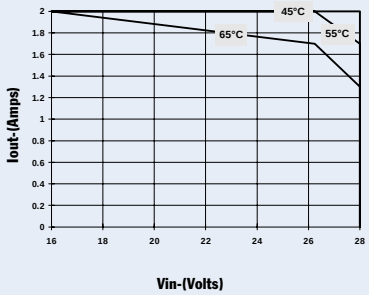
Efficiency vs Output Current



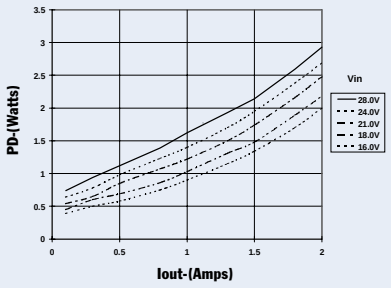
Ripple vs Output Current



Thermal Derating (T_a) (See Note 2)



Power Dissipation vs Output Current



Note 1: *All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the ISR.*
Note 2: *Thermal derating graphs are developed in free air convection cooling of 40-60 LFM. (See Thermal Application Notes.)*

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